

## P-Channel 60 V (D-S) MOSFET

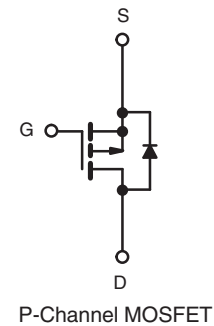
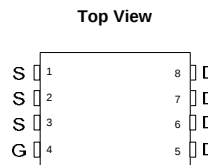
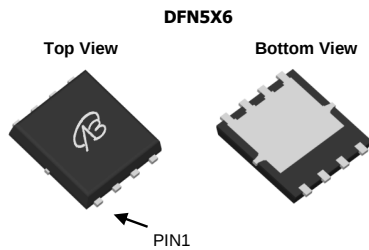
| PRODUCT SUMMARY                                |         |
|------------------------------------------------|---------|
| $V_{DS}$ (V)                                   | -60     |
| $R_{DS(on)}$ ( $\Omega$ ) at $V_{GS} = -10$ V  | 0.014   |
| $R_{DS(on)}$ ( $\Omega$ ) at $V_{GS} = -4.5$ V | 0.022   |
| $I_D$ (A)                                      | -60     |
| Configuration                                  | Single  |
| Package                                        | DFN 5X6 |

### FEATURES

- Trench power MOSFET
- 100 %  $R_g$  and UIS tested



**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**



| ABSOLUTE MAXIMUM RATINGS ( $T_C = 25^\circ\text{C}$ , unless otherwise noted) |                           |                |             |                  |
|-------------------------------------------------------------------------------|---------------------------|----------------|-------------|------------------|
| PARAMETER                                                                     |                           | SYMBOL         | LIMIT       | UNIT             |
| Drain-Source Voltage                                                          |                           | $V_{DS}$       | -60         | V                |
| Gate-Source Voltage                                                           |                           | $V_{GS}$       | $\pm 30$    |                  |
| Continuous Drain Current                                                      | $T_C = 25^\circ\text{C}$  | $I_D$          | -45         | A                |
|                                                                               | $T_C = 125^\circ\text{C}$ |                | -36         |                  |
| Continuous Source Current (Diode Conduction) <sup>a</sup>                     |                           | $I_S$          | -135        |                  |
| Pulsed Drain Current <sup>b</sup>                                             |                           | $I_{DM}$       | -100        |                  |
| Single Pulse Avalanche Current                                                | $L = 0.1$ mH              | $I_{AS}$       | -36         |                  |
| Single Pulse Avalanche Energy                                                 |                           | $E_{AS}$       | 64.8        | mJ               |
| Maximum Power Dissipation <sup>b</sup>                                        | $T_C = 25^\circ\text{C}$  | $P_D$          | 68          | W                |
|                                                                               | $T_C = 125^\circ\text{C}$ |                | 22          |                  |
| Operating Junction and Storage Temperature Range                              |                           | $T_J, T_{stg}$ | -55 to +175 | $^\circ\text{C}$ |
| Soldering Recommendations (Peak Temperature) <sup>d, e</sup>                  |                           |                | 260         |                  |

| THERMAL RESISTANCE RATINGS |                        |            |       |                    |
|----------------------------|------------------------|------------|-------|--------------------|
| PARAMETER                  |                        | SYMBOL     | LIMIT | UNIT               |
| Junction-to-Ambient        | PCB Mount <sup>c</sup> | $R_{thJA}$ | 68    | $^\circ\text{C/W}$ |
| Junction-to-Case (Drain)   |                        | $R_{thJC}$ | 2.2   |                    |

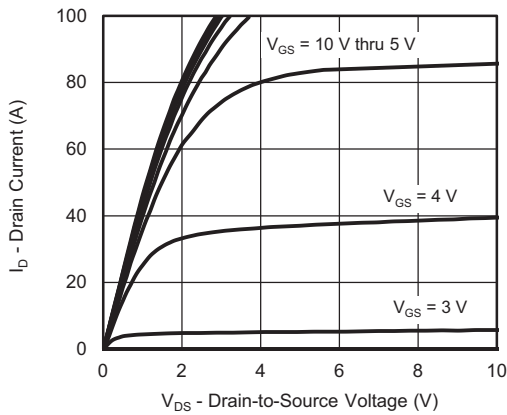
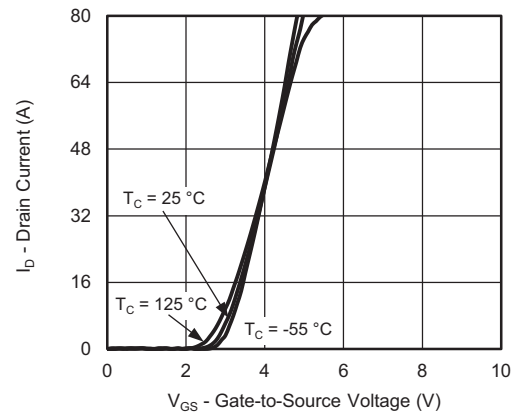
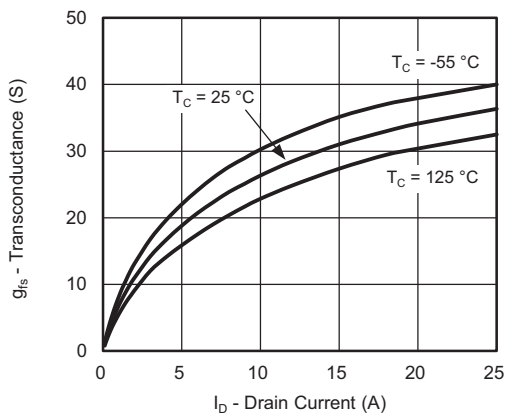
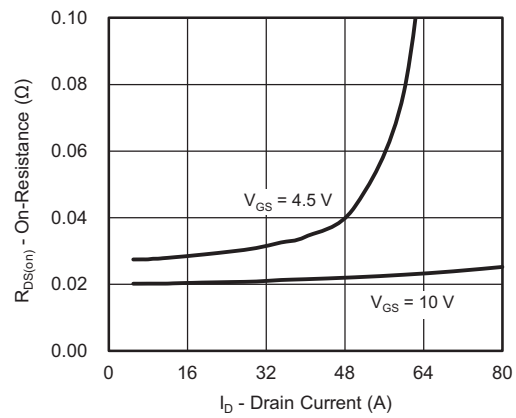
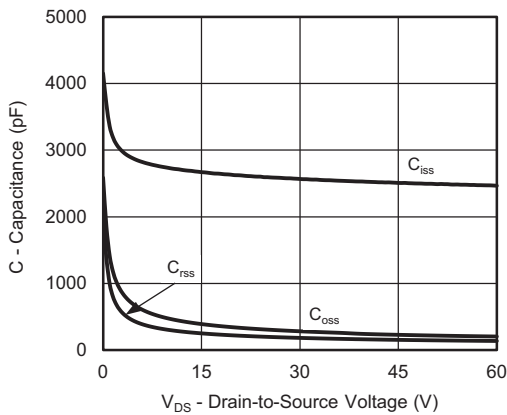
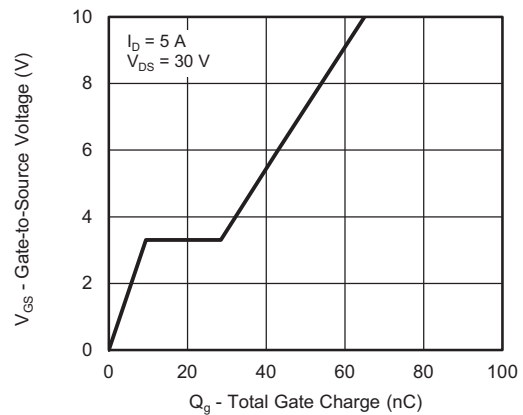
### Notes

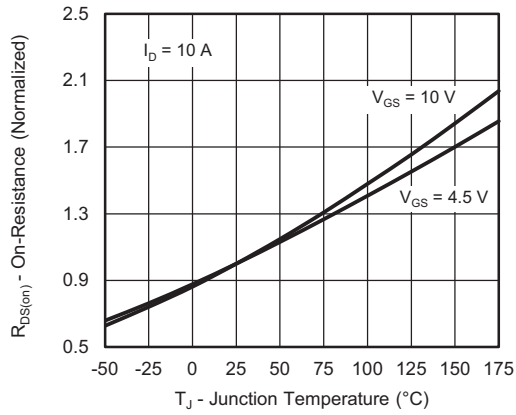
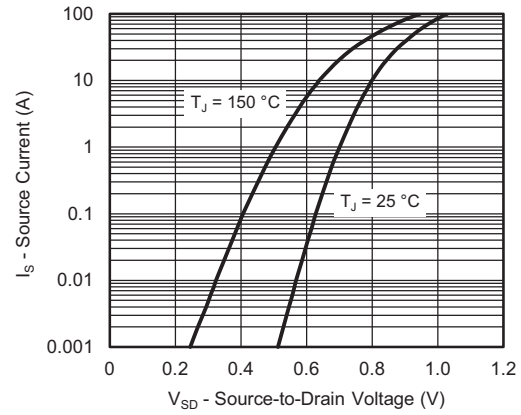
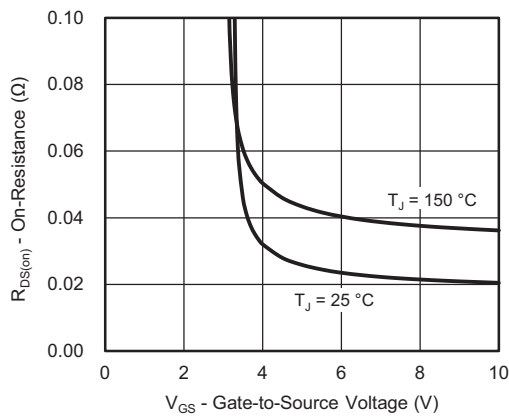
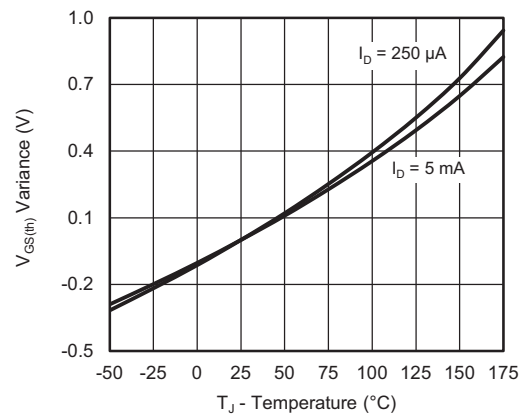
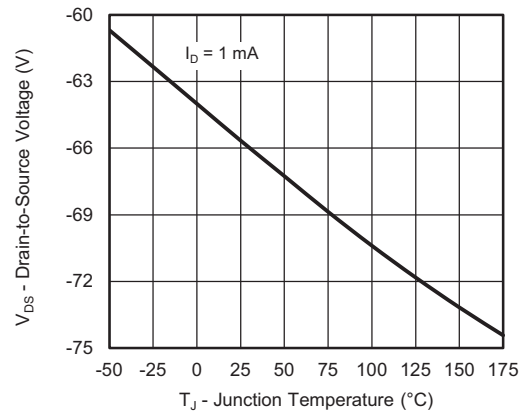
- Package limited.
- Pulse test; pulse width  $\leq 300$   $\mu\text{s}$ , duty cycle  $\leq 2\%$ .
- When mounted on 1" square PCB (FR4 material).

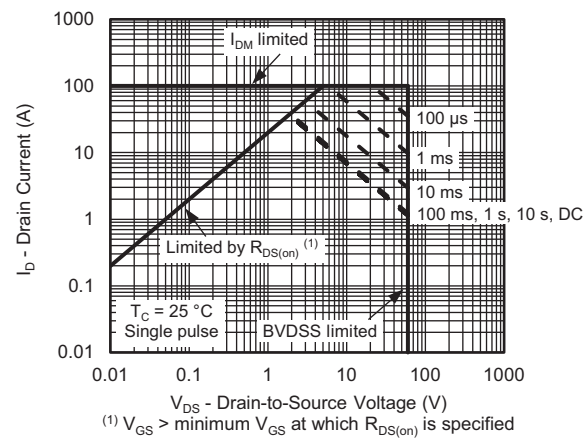
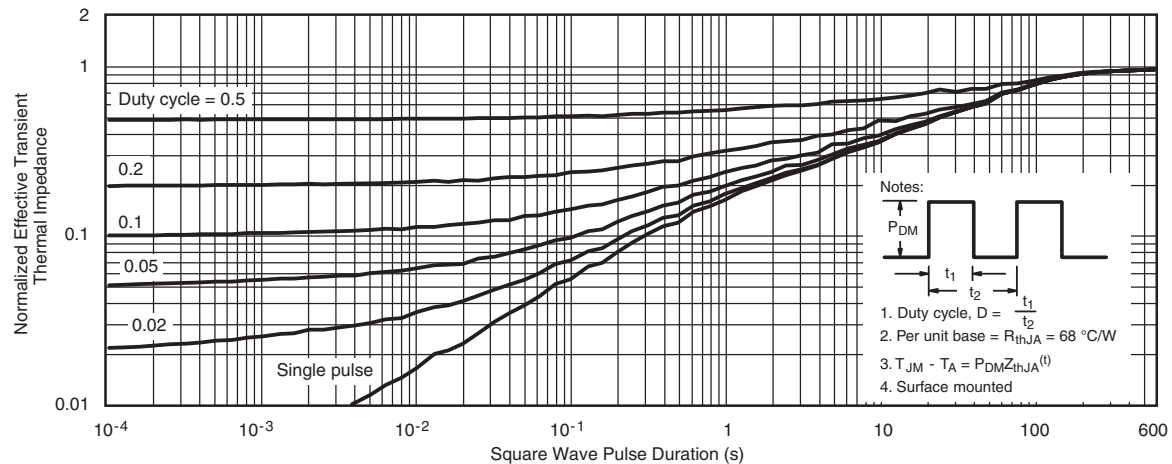
| SPECIFICATIONS (T <sub>C</sub> = 25 °C, unless otherwise noted) |                     |                                                                                                                        |                                                  |      |       |       |      |
|-----------------------------------------------------------------|---------------------|------------------------------------------------------------------------------------------------------------------------|--------------------------------------------------|------|-------|-------|------|
| PARAMETER                                                       | SYMBOL              | TEST CONDITIONS                                                                                                        |                                                  | MIN. | TYP.  | MAX.  | UNIT |
| Static                                                          |                     |                                                                                                                        |                                                  |      |       |       |      |
| Drain-Source Breakdown Voltage                                  | V <sub>DS</sub>     | V <sub>GS</sub> = 0, I <sub>D</sub> = -250 μA                                                                          |                                                  | -60  | -     | -     | V    |
| Gate-Source Threshold Voltage                                   | V <sub>GS(th)</sub> | V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = -250 μA                                                           |                                                  | -1.5 | -     | -3.5  |      |
| Gate-Source Leakage                                             | I <sub>GSS</sub>    | V <sub>DS</sub> = 0 V, V <sub>GS</sub> = ± 30 V                                                                        |                                                  | -    | -     | ± 100 | nA   |
| Zero Gate Voltage Drain Current                                 | I <sub>DSS</sub>    | V <sub>GS</sub> = 0 V                                                                                                  | V <sub>DS</sub> = -60 V                          | -    | -     | -1    | μA   |
|                                                                 |                     | V <sub>GS</sub> = 0 V                                                                                                  | V <sub>DS</sub> = -48 V, T <sub>J</sub> = 125 °C | -    | -     | -50   |      |
|                                                                 |                     | V <sub>GS</sub> = 0 V                                                                                                  | V <sub>DS</sub> = -48 V, T <sub>J</sub> = 175 °C | -    | -     | -150  |      |
| On-State Drain Current <sup>a</sup>                             | I <sub>D(on)</sub>  | V <sub>GS</sub> = -10 V                                                                                                | V <sub>DS</sub> ≥ -5 V                           | -30  | -     | -     | A    |
| Drain-Source On-State Resistance <sup>a</sup>                   | R <sub>DS(on)</sub> | V <sub>GS</sub> = -10 V                                                                                                | I <sub>D</sub> = -10 A                           | -    | 0.014 | -     | Ω    |
|                                                                 |                     | V <sub>GS</sub> = -10 V                                                                                                | I <sub>D</sub> = -10 A, T <sub>J</sub> = 125 °C  | -    | 0.028 | -     |      |
|                                                                 |                     | V <sub>GS</sub> = -10 V                                                                                                | I <sub>D</sub> = -10 A, T <sub>J</sub> = 175 °C  | -    | 0.035 | -     |      |
|                                                                 |                     | V <sub>GS</sub> = -4.5 V                                                                                               | I <sub>D</sub> = -5 A                            | -    | 0.022 | -     |      |
| Forward Transconductance <sup>b</sup>                           | g <sub>fs</sub>     | V <sub>DS</sub> = -15 V, I <sub>D</sub> = -10 A                                                                        |                                                  | -    | 26    | -     | S    |
| Dynamic <sup>b</sup>                                            |                     |                                                                                                                        |                                                  |      |       |       |      |
| Input Capacitance                                               | C <sub>iss</sub>    | V <sub>GS</sub> = 0 V                                                                                                  | V <sub>DS</sub> = -25 V, f = 1 MHz               | -    | 4000  | -     | pF   |
| Output Capacitance                                              | C <sub>oss</sub>    |                                                                                                                        |                                                  | -    | 310   | 450   |      |
| Reverse Transfer Capacitance                                    | C <sub>rss</sub>    |                                                                                                                        |                                                  | -    | 200   | 275   |      |
| Total Gate Charge <sup>c</sup>                                  | Q <sub>g</sub>      | V <sub>GS</sub> = -10 V                                                                                                | V <sub>DS</sub> = -30 V, I <sub>D</sub> = -5 A   | -    | 6.0   | 100   | nC   |
| Gate-Source Charge <sup>c</sup>                                 | Q <sub>gs</sub>     |                                                                                                                        |                                                  | -    | 9.5   | -     |      |
| Gate-Drain Charge <sup>c</sup>                                  | Q <sub>gd</sub>     |                                                                                                                        |                                                  | -    | 19    | -     |      |
| Gate Resistance                                                 | R <sub>g</sub>      | f = 1 MHz                                                                                                              |                                                  | 0.50 | 1.19  | 1.80  | Ω    |
| Turn-On Delay Time <sup>c</sup>                                 | t <sub>d(on)</sub>  | V <sub>DD</sub> = -30 V, R <sub>L</sub> = 6 Ω<br>I <sub>D</sub> ≅ -5 A, V <sub>GEN</sub> = -10 V, R <sub>g</sub> = 1 Ω |                                                  | -    | 15    | 25    | ns   |
| Rise Time <sup>c</sup>                                          | t <sub>r</sub>      |                                                                                                                        |                                                  | -    | 5     | 10    |      |
| Turn-Off Delay Time <sup>c</sup>                                | t <sub>d(off)</sub> |                                                                                                                        |                                                  | -    | 40    | 75    |      |
| Fall Time <sup>c</sup>                                          | t <sub>f</sub>      |                                                                                                                        |                                                  | -    | 6     | 12    |      |
| Source-Drain Diode Ratings and Characteristics <sup>b</sup>     |                     |                                                                                                                        |                                                  |      |       |       |      |
| Pulsed Current <sup>a</sup>                                     | I <sub>SM</sub>     |                                                                                                                        |                                                  | -    | -     | -135  | A    |
| Forward Voltage                                                 | V <sub>SD</sub>     | I <sub>F</sub> = -10 A, V <sub>GS</sub> = 0 V                                                                          |                                                  | -    | -0.80 | -1.2  | V    |

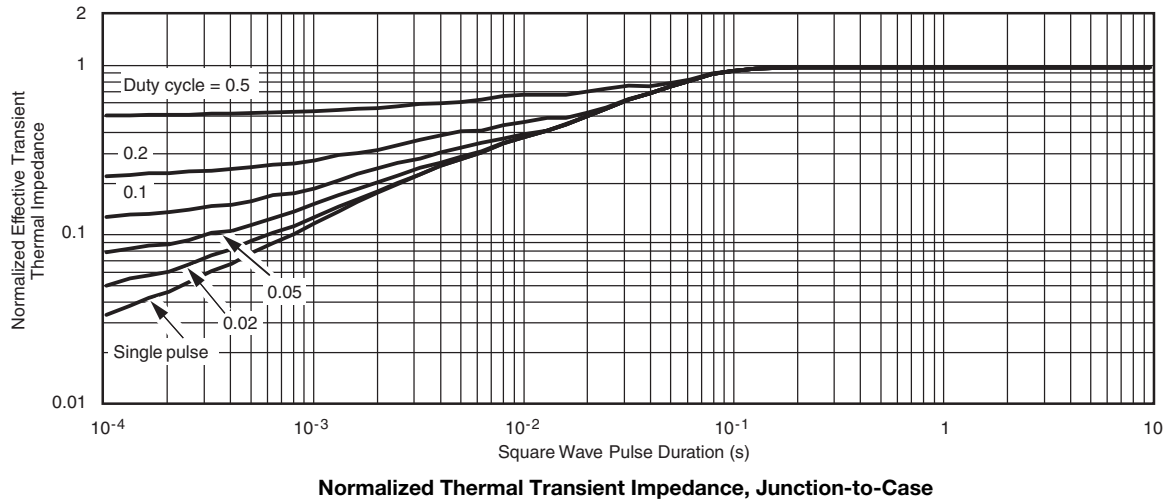
**Notes**

- a. Pulse test; pulse width  $\leq 300\text{ }\mu\text{s}$ , duty cycle  $\leq 2\%$ .  
 b. Guaranteed by design, not subject to production testing.  
 c. Independent of operating temperature.

**TYPICAL CHARACTERISTICS** ( $T_A = 25^\circ\text{C}$ , unless otherwise noted)

**Output Characteristics**

**Transfer Characteristics**

**Transconductance**

**On-Resistance vs. Drain Current**

**Capacitance**

**Gate Charge**

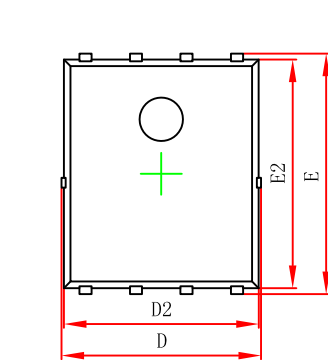
**TYPICAL CHARACTERISTICS** ( $T_A = 25\text{ }^{\circ}\text{C}$ , unless otherwise noted)

**On-Resistance vs. Junction Temperature**

**Source Drain Diode Forward Voltage**

**On-Resistance vs. Gate-to-Source Voltage**

**Threshold Voltage**

**Drain-Source Breakdown vs. Junction Temperature**

**THERMAL RATINGS** ( $T_C = 25\text{ }^{\circ}\text{C}$ , unless otherwise noted)

**Safe Operating Area**

**Normalized Thermal Transient Impedance, Junction-to-Ambient**

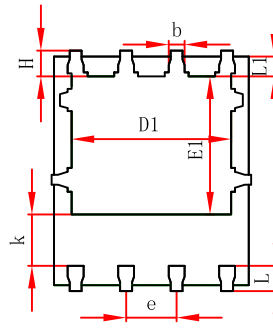
**THERMAL RATINGS** ( $T_C = 25\text{ }^{\circ}\text{C}$ , unless otherwise noted)**Note**

- The characteristics shown in the two graphs
  - Normalized Transient Thermal Impedance Junction-to-Ambient ( $25\text{ }^{\circ}\text{C}$ )
  - Normalized Transient Thermal Impedance Junction-to-Case ( $25\text{ }^{\circ}\text{C}$ )are given for general guidelines only to enable the user to get a “ball park” indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

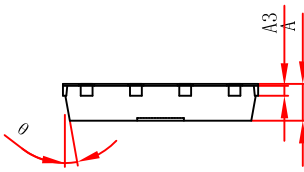
## PDFNWB5x6-8L Package Outline Dimensions



Top View  
[顶视图]



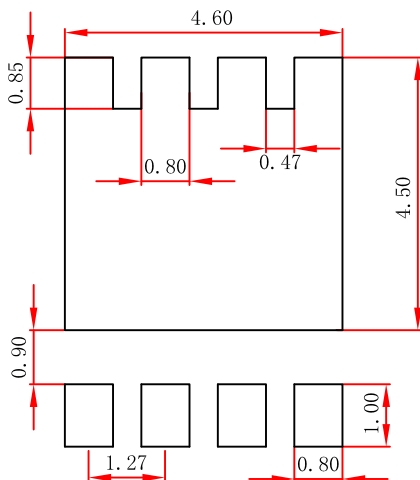
Bottom View  
[背视图]



Side View  
[侧视图]

| Symbol | Dimensions in Millimeters |       | Dimensions in Inches |       |
|--------|---------------------------|-------|----------------------|-------|
|        | Min.                      | Max.  | Min.                 | Max.  |
| A      | 0.900                     | 1.000 | 0.035                | 0.039 |
| A3     | 0.254REF.                 |       | 0.010REF.            |       |
| D      | 4.944                     | 5.096 | 0.195                | 0.201 |
| E      | 5.974                     | 6.126 | 0.235                | 0.241 |
| D1     | 3.910                     | 4.110 | 0.154                | 0.162 |
| E1     | 3.375                     | 3.575 | 0.133                | 0.141 |
| D2     | 4.824                     | 4.976 | 0.190                | 0.196 |
| E2     | 5.674                     | 5.826 | 0.223                | 0.229 |
| k      | 1.190                     | 1.390 | 0.047                | 0.055 |
| b      | 0.350                     | 0.450 | 0.014                | 0.018 |
| e      | 1.270TYP.                 |       | 0.050TYP.            |       |
| L      | 0.559                     | 0.711 | 0.022                | 0.028 |
| L1     | 0.424                     | 0.576 | 0.017                | 0.023 |
| H      | 0.574                     | 0.726 | 0.023                | 0.029 |
| θ      | 10°                       |       | 12°                  |       |

## PDFNWB5x6-8L Suggested Pad Layout



### Note:

1. Controlling dimension: in millimeters.
2. General tolerance:  $\pm 0.05\text{mm}$ .
3. The pad layout is for reference purposes only.

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